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INTERNATIONAL STANDARD



Printed electronic Feh STANDARD PREVIEW

Part 202-6: Materials – Conductive ink – Measurement method for resistance changes under high temperature and humidity – Printed conductive layer on a flexible substrate

<u>IEC 62899-202-6:2020</u>

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

PRINTED ELECTRONICS -

Part 202-6: Materials – Conductive ink – Measurement method for resistance changes under high temperature and humidity – Printed conductive layer on a flexible substrate

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The text of this International Standard is based on the following documents:

FDIS	Report on voting
119/323/FDIS	119/331/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62899 series, published under the general title *Printed electronics*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
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INTRODUCTION

The printing process is a highly promising technology for fabricating flexible devices due to its high conductivity and productivity. In particular, a printed conductive layer on a flexible substrate will be widely employed as an electrode or an interconnect for flexible devices. It will be dealt with and commercialized as a sort of composite material in which the conductive layer is formed on the substrate as a conductor.

For conductive films, silver/copper nanowires or metal mesh on flexible substrate are a key component for many recently developed electronic products, from smart phones to the keypads of appliances such as refrigerators and washing machines. Although the conventional material for transparent conductive films is indium tin oxide (ITO), transparent conductive films, enabled by printed electronics technologies, have arisen as a replacement. For application of conductive films, the electrical property under environmental conditions such as temperature, humidity, light, etc., is very important because it is highly sensitive to the environment because of oxidation, dissolution, melting, etc [1]1. The conductive films should be stored on a shelf and should be environmentally stable during their operation in electronic devices. Therefore, a method and environment for transferring, storing, and processing the conductivity film are sometimes provided by the supplier and include environmental measurements for printed devices. Although some environmental conditions for testing already exist, the unique characteristics of the printed conductive films should be considered, because they are fabricated on a polymer substrate which is susceptible to temperature, humidity, light, etc., unlike the conventional ITO transparent conductive films.

In this document, an environment reliability test is proposed to evaluate the electrical property and resistance change of a printed conductive film on a flexible substrate.

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¹ Numbers in square brackets refer to the Bibliography.

PRINTED ELECTRONICS -

Part 202-6: Materials – Conductive ink – Measurement method for resistance changes under high temperature and humidity – Printed conductive layer on a flexible substrate

1 Scope

This part of IEC 62899 provides a method of in-situ measurement for the resistance change of a conductive layer formed by printing methods on a flexible substrate under specified temperature and humidity conditions.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62899-201, Printed electronics - Part 201: Materials - Substrates

IEC 62899-202, Printed electronics 2 Part 202. Materials - Conductive ink

IEC 62899-202-5, Printed electronics EPart 202-5: Materials — Conductive ink — Mechanical bending test of a printed conductive layer on an insulating substrate 53-9e4a-218ee | Ibe | 148/iec-62899-202-6-2020

3 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at http://www.electropedia.org/
- ISO Online browsing platform: available at http://www.iso.org/obp

3.1

conductive ink

ink using metal particles as a main conductive component, in which one or more small molecules, oligomers, polymers, or particles are dissolved or dispersed, and which becomes an electrically conductive layer by post-treatment such as annealing by heating, lighting or chemical treating

Note 1 to entry: Metal particles are specified in IEC 62899-202.

3.2

conductive layer

electrically conductive film-like layer fabricated with conductive ink, which is printed or coated on a substrate, followed as necessary by post-treatment such as annealing by heating, lighting or chemical treating

3 3

flexible substrate

flexible substrate on which conductive ink is printed, such as a plastic film

4 Test sample and measurement equipment

4.1 General

The test sample for environmental testing shall be prepared using a conductive ink on a substrate.

4.2 Sample shape and size for measuring resistance change

A sample with a rectangular shape with a ratio over 20 is recommended.

The tolerance of width and length is 5 % (see IEC 62899-201 and IEC 62899-202).

The recommended sample size is 200 mm × 10 mm.

Another sample size of which the ratio of the longer side over the shorter side is at least 20 may be used for in situ environmental test.

5 Test conditions Teh STANDARD PREVIEW

5.1 General (standards.iteh.ai)

The electrical resistance changes of a conductive film shall be measured during the environmental test inside a temperature and humidity controlled chamber. The test shall be measured under atmospheric pressure. The test shall be measured under atmospheric pressure. The environmental test inside a temperature and humidity controlled chamber. The test shall be measured under atmospheric pressure.

5.2 Test conditions under temperature and humidity

Unless otherwise specified, the test temperature and humidity shall be (85 ± 2) °C and (85 ± 5) %, respectively (see Annex A).

When testing at another temperature and humidity, the tolerance range for the test temperature shall be within ± 2 °C and the tolerance for the test humidity shall be within ± 5 %.

5.3 Test conditions at high temperature

Unless otherwise specified, test temperature shall be (120 ± 2) °C.

However, the test temperature shall not exceed the glass transition temperature $(T_{\rm g})$ of the polymer used in the substrate of the test specimen. When $T_{\rm g}$ is lower than 120 °C, the test temperature shall be 15 °C lower than $T_{\rm g}$ in the substrate, with a tolerance of ± 2 °C.

5.4 Test conditions for thermal cycling

Unless otherwise specified, the thermal cycling test shall be carried out at the following temperature cycle:

- 1) keep at (-20 ± 2) °C for 30 min,
- 2) increase to (80 ± 2) °C within 30 min,
- 3) keep at (80 ± 2) °C for 30 min,
- 4) decrease to (-20 ± 2) °C within 30 min.

Repeat 1) to 4).

The relative humidity shall be kept at (50 ± 5) % throughout the test and condensation on the sample should be avoided.

6 Test method and test apparatus

6.1 General

A printed conductive film is placed in a chamber which can control the temperature and humidity. Place the sample paying attention to the humidity distribution in the chamber.

To measure resistance change, test sample can be placed on a rigid plate and fixed with screws for connection with the measuring equipment, as shown in Figure 1 to Figure 3. The test sample is connected with two or four conductive wires to the measuring equipment.



Figure 1 – Schematic diagram of environmental test jig of printed conductive film for two-wire measurement

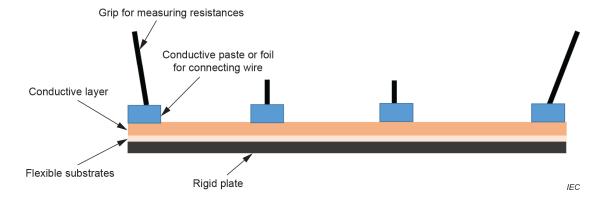


Figure 2 – Schematic diagram of environmental test jig of printed conductive film for four-wire measurement

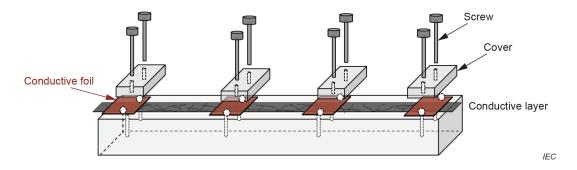


Figure 3 – Schematic diagram of environmental test jig of printed conductive film with screws for a four-wire measurement

NOTE The sample is placed paying attention to the humidity distribution in the chamber.

6.2 Test apparatus

As shown in Figure 1, for the environmental test, the conductive film shall be placed on a plate to reduce the interference from flexibility.

The plates shall be clean, smooth, and rigid to avoid damaging the samples. For the electrical measurement, the grip, shown in Figure 4, shall be made from a conductive metal grip for electrical connection, but the plate shall be made from insulating materials such as resin, polycarbonate, mono cast nylon, etc. The covers and the screws in Figure 1 to Figure 3 shall have the same properties as the plates. The plate and cover shall have a resistance larger than $10^6~\Omega$, and no deformation shall be allowed during the temperature and humidity test.



Figure 4 - Image of metal grip for connection

IFC

All plates and materials shall be stable at a temperature from $-30~^{\circ}\text{C}$ to 150 $^{\circ}\text{C}$ with 90 % relative humidity for the test duration.

6.3 Test procedure

The test procedure is as follows:

- a) Prepare the conductive film.
- b) Place the conductive film on a rigid plate and grip the sample.
- c) Place the sample inside the chamber with controllable temperature and humidity.
- d) Connect the two- or four-wire electrical connections for measuring resistance to the measurement equipment, which should be outside of the chamber.
- e) Measure the initial resistance.
- f) For the test method given in 5.2 to 5.4, set up the temperature and humidity to reach the target temperature and humidity.
- g) Measure the resistance.